

## ■ INTRODUCTION

SN6A513 is a series of single chip voice/dual tone melody synthesizer IC with 16\*64/8\*64 LCD direct drive capability which contains two 4-bit I/O ports, two optional 4-bit output ports and a tiny controller. By programming through the tiny controller, user's application including LCD display, section combination, trigger modes, output status, voice/melody playing and other logic functions and then be easily implemented.

## FEATURES

- Single power supply 2.4V 5.1V
- Built in a tiny controller
- Two 4-bit I/O ports, two optional 4-bit output ports are provided
- 256\*4 bits RAM for programming usage are provided
- ◆ 256\*4 bits RAM for LCD display usage are provided
- Maximum 810k\*10 program ROM is provided
- Readable ROM code data
- Built in direct 16\*64/8\*64 LCD driver
- LCD 1/4 bias, 1/5 bias; 1/8 duty, 1/16 duty
- Built in a high quality speech synthesizer
- ◆ Adaptive playing speed from 2.5k-40kHz is provided
- Built in a dual tone melody generator
- Speech/Dual tone melody mixer is provided which SN6A513 series can play speech and dual tone melody simultaneously
- Fixed current D/A output is provided to drive external connected transistor for sound output
- PWM output is provided to drive external connected piezo buzzer



### PIN ASSIGNMENT

Symbol	I/O	Function Description		
SEG1-SEG56	0	Seg 1- Seg 56 for LCD driver		
SEG57/P53-	0	Optional to be Seg57-60 or P53-P50		
SEG60/P50		Seg57-60: Seg57-Seg60 for LCD driver.		
		P53-P50: Bit3-bit0 for output port 5.		
SEG61/P43-	0	Optional to be Seg61-64 or P43-P40		
SEG64/P40		SEG61-64: Seg61-Seg64 for LCD driver.		
		P43-P40: Bit3-bit0 for output port 4.		
COM1-COM16	0	Com1-Com16 for LCD driver.		
GND	I	Negative power supply.		
P33-P30	I/O	Bit 3 to bit 0 of IO port 3.		
P23-P20	I/O	Bit 3 to bit 0 of IO port 2.		
BU1,BU2	0	Buzzer driver outputs.		
VO	0	D/A current output.		
RST	I	Reset pin with internal pull low.		
OSC	I	Oscillation component connection pin.		
TEST	I	For testing only.		
XIN,XOUT		32768 Hz Crystal connection pins.		
V <sub>DD</sub>	I	Positive power supply.		
VLCDR		LCD voltage adjusting pin.		
VLC1-VLC4		LCD voltage bias connection pins.		
WSUB	I	Well substrate of chip. Connected to the		
		highest voltage of chip (VDD or VLCDR).		



### ■ ABSOLUTELY MAXIMUM RATING

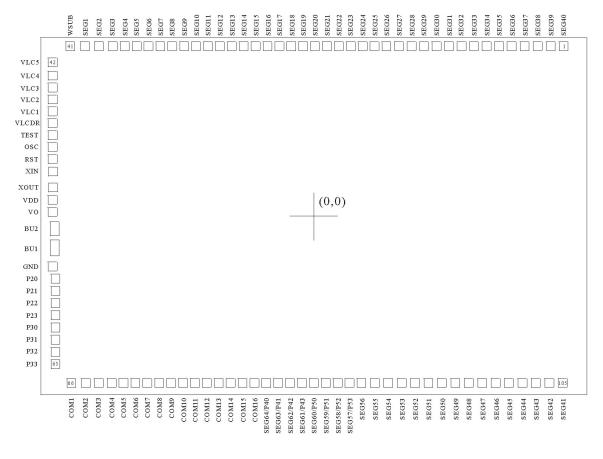
Items	Symbol	Min	Max	Unit.
Supply Voltage	V <sub>DD</sub> -V	-0.3	6.0	V
Input Voltage	V <sub>IN</sub>	V <sub>SS</sub> -0.3	V <sub>DD</sub> +0.3	V
Operating	T <sub>OP</sub>	-20.0	70.0	°C
Temperature				
Storage Temperature	T <sub>STG</sub>	-55.0	125.0	°C

# ■ ELECTRICAL CHARACTERISTIC

ltem	Sym.	Min.	Тур.	Max.	Unit	Condition
Operating Voltage	$V_{DD}$	2.4	3.0	5.1	V	
Standby current 1	I <sub>SBY1</sub>	-	-	1.0	иA	V <sub>DD</sub> =3V,both system clk and 32768 Hz clk are off
Standby current 2	I <sub>SBY2</sub>	-	20	50	uА	V <sub>DD</sub> =3V, system clk is off, 32768 Hz clk is on for LCD display and timer.
Operating current	I <sub>OPR</sub>	-	350	500	uА	$V_{DD}$ =3V, no load
Input current of ,P2,P3	I <sub>IH</sub>	-	3.0	10.0	иA	V <sub>DD</sub> =3V,V <sub>IN</sub> =3V
Drive current of P2,P3,P4,P5	I <sub>OD</sub>	-1.5	-2	-	mA	V <sub>DD</sub> =3V,V <sub>0</sub> =2.6V
large Sink current of P2,P3,P4,P5	I <sub>OS1</sub>	2.0	3	-	mA	V <sub>DD</sub> =3V,V <sub>O</sub> =0.4V
Small Sink current of P2,P3,P4,P5	I <sub>OS2</sub>	-	0.4	-	иА	V <sub>DD</sub> =3V,V <sub>O</sub> =0.4V
D/A output current	$I_{VO}$	2.0	3.0	4.0	mА	V <sub>DD</sub> =3V,V <sub>O</sub> =0.7V
Buzzer drive current	I <sub>BZD</sub>		-15		mA	V <sub>DD</sub> =3V,V <sub>O</sub> =1.5V
Buzzer sink current	<b>I</b> <sub>BZS</sub>		15		mA	V <sub>DD</sub> =3V,V <sub>O</sub> =1.5V
Oscillation resistor	R	-	1.0	-	MHZ	V <sub>DD</sub> =3V
Oscillation Freq.	Fosc	-	1.0	-	MHZ	V <sub>DD</sub> =3V



# BONDING PAD



### SN6A513

Note: The substrate MUST be connected to Vss in PCB layout.



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